



【大阪勤務】 Application Engineer ～スイスの半導体製造装置メーカー～

外資系装置メーカーでの募集です。アプリケーションエンジニアのご経験のある方は...

Job Information

Recruiter

JAC Recruitment Co., Ltd.

Hiring Company

外資系装置メーカー

Job ID

1492321

Industry

Electronics, Semiconductor

Company Type

International Company

Job Type

Permanent Full-time

Location

Osaka Prefecture

Salary

6 million yen ~ 8 million yen

Work Hours

09:00 ~ 18:00

Holidays

【有給休暇】入社7ヶ月目には最低10日以上 【休日】週休二日制 ※緊急時は土日に勤務を行い代休を取得して頂くことがございます。

Refreshed

April 25th, 2025 06:00

General Requirements

Career Level

Mid Career

Minimum English Level

Fluent

Minimum Japanese Level

Native

Minimum Education Level

High-School

Visa Status

Permission to work in Japan required

Job Description

【求人No NJB2246591】

～Overview～

A Swiss based MNC company specialized in development production and sales of high tech evaporation and sputtering machines for semiconductor optics and optoelectronic manufacturers. We are active on a global perspective with entities in North America Germany Singapore and Malaysia.

Currently we are further increasing our foot print in Asia with entities in Japan China and Taiwan.

The key responsibility of this position as Application Engineer is to support our high volume PVD (Physical Vapor Deposition) equipment used in the manufacturing of semiconductor applications for the LED Power Electronics Optics and Wireless Communication industries.

[Duties and Responsibilities]

- Providing On Site Support to customers using equipment for the manufacturing requirements
- Conducting and being responsible for sputter evaporator process application support Technical Acceptance Test (FAT) equal results to Internal Acceptance Test at manufacturing site or FAT of equipment at customer site
- Ability to troubleshoot diagnose and repair products in both hardware and process related issue
- Communication with our technical support team locally and project managers of the business unit in Switzerland to ensure corrective actions are taken efficiently and precisely
- Travelling upon business needs to other region.
- Working independently and in a team environment
- Acting as a liaison between customers and headquarters to ensure all concerns are addressed accurately and effectively for long term resolution and customer relationship
- Providing written reports about FAT problem analysis root cause findings open issue list (OIL) etc. to BU
- Coordinate the teleconference call between customer and headquarter team on continue improvement platform (CIP) activities.

[トレーニングについて]

ご入社後、1~3ヵ月スイス本社にて装置のトレーニングを行います。その後日本に戻り勤務を開始致します。状況によってはアジアの他拠点で製品のトレーニングを受けることもございます。

Required Skills

[Skills Specifications]

- Excellent written and oral communication skills in English Japanese language.
- Ability to read technical drawings (mechanical and electrical)
- Electrical and mechanical skills
- High capability to solve technical problems in a structured and efficient way
- Be able to quickly adapt to new circumstances
- Good decision making skills
- Ability to prepare report in a structured way
- Ability to encourage and motivate people with responsible attitude
- Ability to travel

[Education and Background]

- Associate or bachelor's degree in engineering is preferred
- Minimum of 5 years experiences in customer service or application engineer related to sputtering equipment in Semiconductor LED.

Company Description

ご紹介時にご案内いたします